

#### **MOSFET**

### OptiMOS™ 7 Power-Transistor, 40 V

#### **Features**

- N-channel, normal level
- Enhanced SOA
- Drives optimized
- Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

### **Product validation**

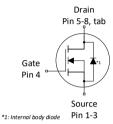
Qualified for industrial applications according to the relevant tests of JEDEC JESD47, JESD22 and J-STD-020.

Table 1 Key performance parameters

Parameter	Value	Unit
$V_{\mathrm{DS}}$	40	V
R <sub>DS(on),max</sub>	1.25	mΩ
$I_{D}$	219	A
$Q_{OSS}$	58	nC
$Q_G(0V10V)$	45	nC
Q <sub>rr</sub> (100A/μs)	30	nC









Part number	Package	Marking	Related links
ISC012N04NM7V	PG-TDSON-8	12N04NM7	-

### Public

# OptiMOS™ 7 Power-Transistor, 40 V ISC012N04NM7V



## Table of contents

Description	1
Maximum ratings	3
Thermal characteristics	4
Electrical characteristics	5
Electrical characteristics diagrams	7
Package outlines	11
Revision history	14
Trademarks	15
Disclaimer	15

## OptiMOS™ 7 Power-Transistor, 40 V ISC012N04NM7V



## 1 Maximum ratings

at  $T_{\Delta}$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Darameter	Symbol	Values			l lmit	Note / Test condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test condition	
				219		$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C	
o .:	<b>,</b>		-	155		$V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C	
Continuous drain current 1)	I <sub>D</sub>	-		162	A	$V_{\rm GS}$ =15 V, $T_{\rm C}$ =100 °C	
				35		$V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =50 °C/W <sup>2)</sup>	
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	876	А	<i>T</i> <sub>C</sub> =25 °C	
Avalanche energy, single pulse 4)	E <sub>AS</sub>	-	-	105	mJ	$I_{\rm D} = 50  \text{A},  R_{\rm GS} = 25  \Omega$	
Gate source voltage	$V_{\rm GS}$	-20	-	20	V	-	
Power dissipation		-	-	115	147	<i>T</i> <sub>c</sub> =25 °C	
	$P_{\text{tot}}$			3.0	W	T <sub>A</sub> =25 °C, R <sub>thJA</sub> =50 °C/W <sup>2)</sup>	
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-55	-	175	°C	-	

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^2$  (one layer, 70  $\mu$ m thick) copper area for drain connection. PCB is vertical in still air.

<sup>3)</sup> See Diagram 3 for more detailed information

<sup>4)</sup> See Diagram 13 for more detailed information

# OptiMOS™ 7 Power-Transistor, 40 V ISC012N04NM7V



## 2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test condition
	Syllibot	Min.	Тур.	Max.		Note / Test condition
Thermal resistance, junction - case, bottom	$R_{thJC}$			1.3		
Thermal resistance, junction - case, top	$R_{thJC}$	-	-	20	°C/W	-
Thermal resistance, junction - ambient, 6 cm <sup>2</sup> cooling area <sup>5)</sup>	$R_{ m thJA}$			50		

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^2$  (one layer, 70  $\mu$ m thick) copper area for drain connection. PCB is vertical in still air.

## OptiMOS™ 7 Power-Transistor, 40 V ISC012N04NM7V



## 3 Electrical characteristics

at  $T_{\rm j}$ =25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			l lnit	Note / Test condition	
Parameter	Syllibot	Min.	Тур.	Max.	Onic	Note / Test condition	
Drain-source breakdown voltage	$V_{(BR)DSS}$	40	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	2.35	2.75	3.15	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 46  \mu \text{A}$	
7	,	-	0.1	1		$V_{\rm DS}$ =40 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C	
Zero gate voltage drain current	I <sub>DSS</sub>		10	100	μΑ	$V_{\rm DS}$ =40 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C	
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	$V_{\rm GS}$ =20 V, $V_{\rm DS}$ =0 V	
Drain-source on-state resistance	D	-	0.97	1.15	mΩ	$V_{\rm GS}$ =15 V, $I_{\rm D}$ =50 A	
	$R_{\rm DS(on)}$		1.1	1.25	111122	$V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A	
Gate resistance	$R_{G}$	-	0.8	-	Ω	-	
Transconductance	$g_{fs}$	-	120	-	S	$ V_{\rm DS}  \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D} = 50 \text{ A}$	

Table 5 Dynamic characteristics

Parameter	Symbol	Values			llnit	Note / Test condition
	Symbol	Min.	Тур.	Max.	Oilit	Note / Test condition
Input capacitance <sup>6)</sup>	C <sub>iss</sub>		3000			
Output capacitance <sup>6)</sup>	Coss	_	1600	- pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =20 V, <i>f</i> =1 MHz	
Reverse transfer capacitance <sup>6)</sup>	C <sub>rss</sub>		36			
Turn-on delay time	t <sub>d(on)</sub>		9.7			
Rise time	t <sub>r</sub>	- -	4.0		nc	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Turn-off delay time	$t_{\sf d(off)}$		17	-	ns	
Fall time	$t_{f}$		5.4			

<sup>&</sup>lt;sup>6)</sup> Defined by design. Not subject to production test.

## OptiMOS™ 7 Power-Transistor, 40 V ISC012N04NM7V



Table 6 Gate charge characteristics 7)

Parameter	Symbol		Values			Note / Test condition
	Symbol	Min.	Тур.	Max.	Onic	Note / Test condition
Gate to source charge	$Q_{\rm gs}$		15	-	nC	
Gate charge at threshold	$Q_{\mathrm{g(th)}}$	8.2 - nC 10 - nC 17 - nC 45 56 nC	8.2	-	nC	
Gate to drain charge	$Q_{\mathrm{gd}}$		10	-	nC	 
Switching charge	$Q_{sw}$		17	-	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total <sup>8)</sup>	$Q_{ m g}$					
Gate plateau voltage	$V_{ m plateau}$		5.0	-	V	
Gate charge total, sync. FET	$Q_{\mathrm{g(sync)}}$	-	41	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 10 V
Output charge	Q <sub>oss</sub>	-	58	-	nC	V <sub>DS</sub> =20 V, V <sub>GS</sub> =0 V

<sup>7)</sup> See "Gate charge waveforms" for parameter definition

#### Table 7 Reverse diode

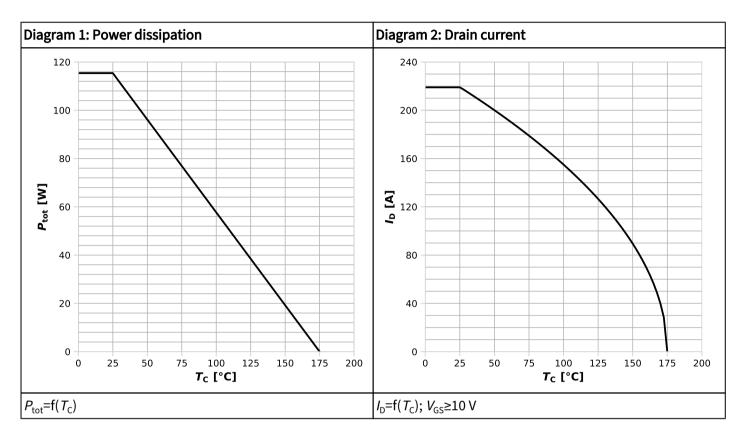
Parameter	Symbol	Values			Linit	Note / Test condition	
raiailletei	Symbol	Min.	Тур.	Max.	Oilit	Note / Test condition	
Diode continuous forward current	Is			113	Α	T <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	_	908	Α		
Diode forward voltage	$V_{\rm SD}$	-	0.82	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =50 A, $T_{\rm j}$ =25 °C	
Reverse recovery time <sup>9)</sup>	t <sub>rr</sub>		35		ns	1/-20 \/	
Reverse recovery charge <sup>9)</sup>	$Q_{\rm rr}$	30		nC	V <sub>R</sub> =20 V, I <sub>F</sub> =50 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs		

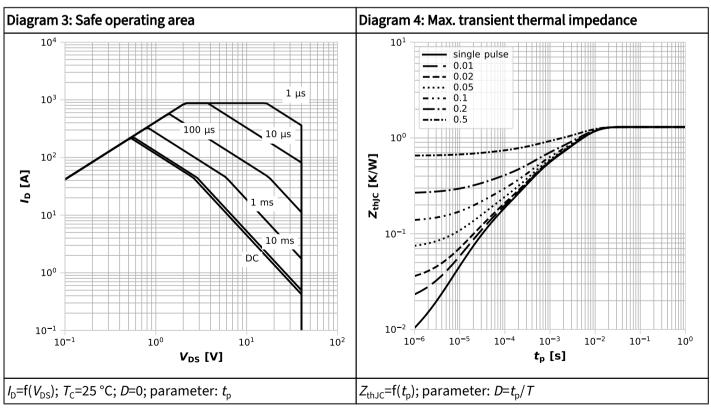
<sup>&</sup>lt;sup>9)</sup> Defined by design. Not subject to production test.

<sup>8)</sup> Defined by design. Not subject to production test.

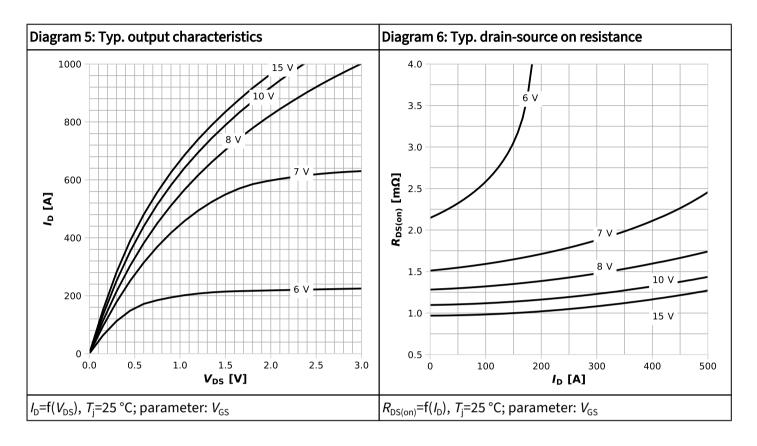


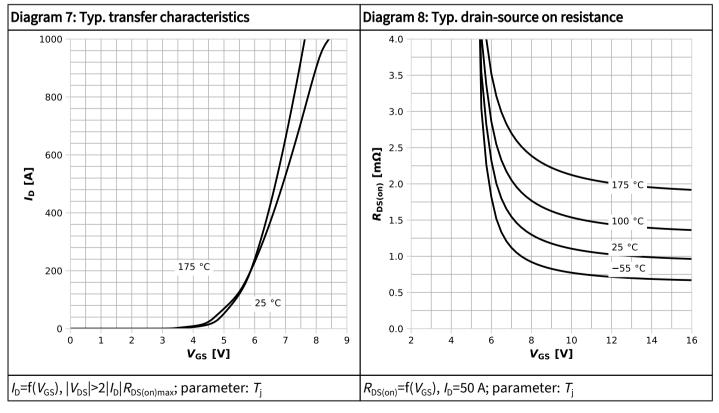
## 4 Electrical characteristics diagrams



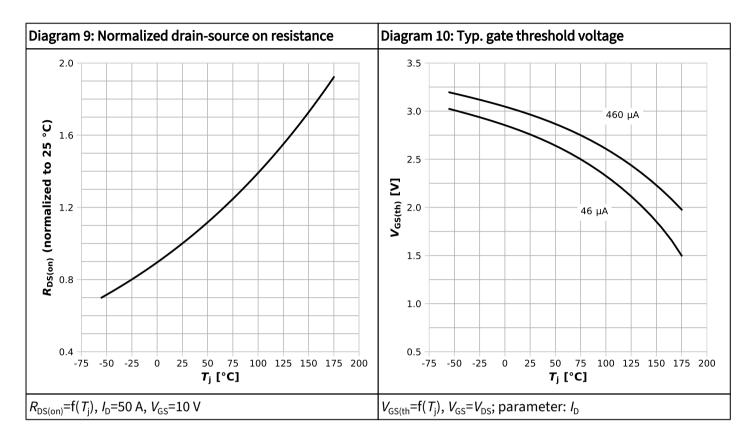


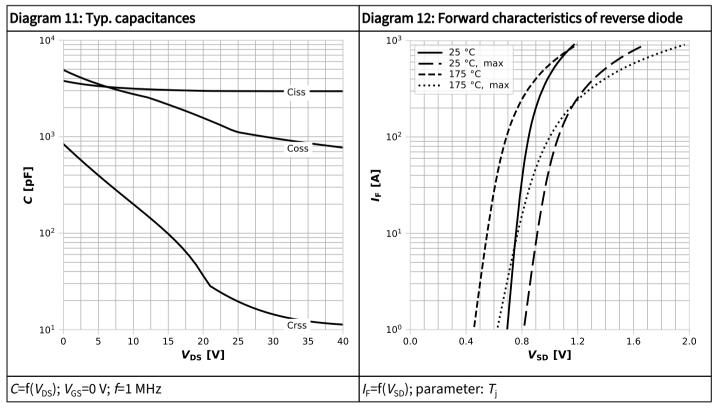




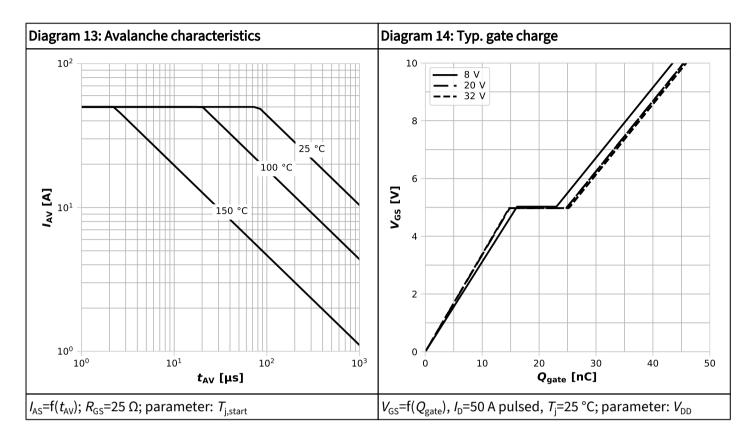


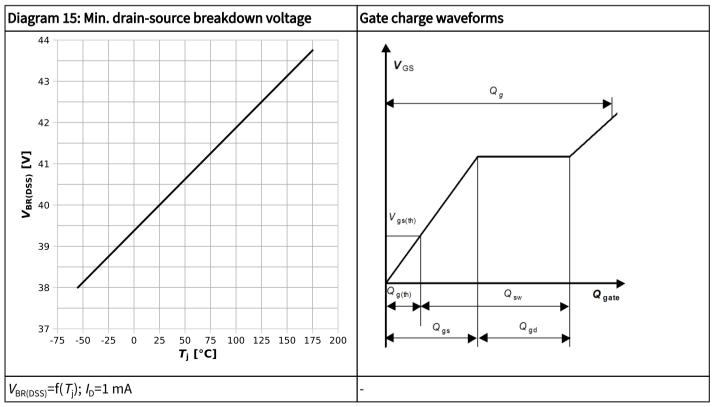














## 5 Package outlines

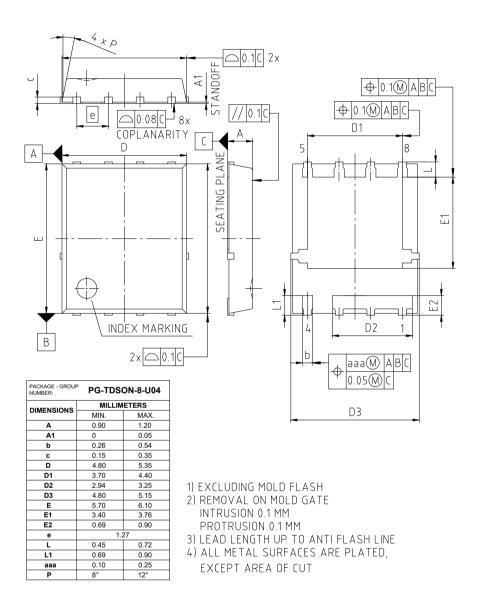


Figure 1 Outline PG-TDSON-8, dimensions in mm



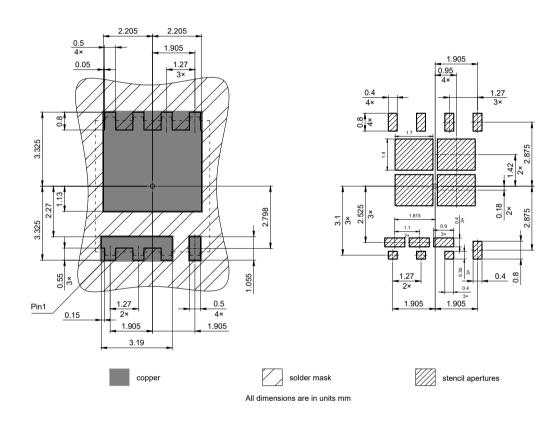


Figure 2 Footprint drawing PG-TDSON-8, dimensions in mm



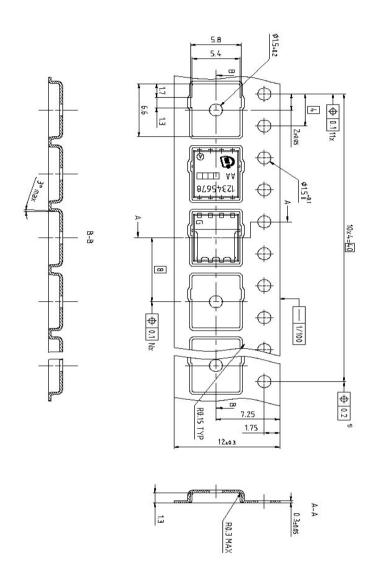


Figure 3 Packaging variant PG-TDSON-8, dimensions in mm

### Public

# OptiMOS™ 7 Power-Transistor, 40 V ISC012N04NM7V



## **Revision history**

ISC012N04NM7V

### Revision 2025-04-22, Rev. 1.0

**Previous revisions** 

Revision	Date	Subjects (major changes since last revision)
1.0	2025-04-22	Release of final version

#### **Public**

## OptiMOS™ 7 Power-Transistor, 40 V ISC012N04NM7V



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